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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/618,067	07/11/2003	Jifa Hao	90065.000701/17732.6357.0 4314	
44331 LUSCOCK & F	7590 11/16/2007		EXAMINER	
HISCOCK & BARCLAY, LLP 2000 HSBC PLAZA			ROSE, KIESHA L	
	100 Chestnut Street ROCHESTER, NY 14604-2404		ART UNIT	PAPER NUMBER
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			MAIL DATE	DELIVERY MODE
			11/16/2007	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

		Application No.	Applicant(s)		
		10/618,067	HAO ET AL.		
	Office Action Summary	Examiner	Art Unit		
		Kiesha L. Rose	2822		
Period for	The MAILING DATE of this communication app	ears on the cover sheet with the c	orrespondence address		
A SHC WHICI - Extens after S - If NO p - Failure Any re	PRIENT STATUTORY PERIOD FOR REPLY HEVER IS LONGER, FROM THE MAILING DASIONS of time may be available under the provisions of 37 CFR 1.13 (IX (6) MONTHS from the mailing date of this communication. Deriod for reply is specified above, the maximum statutory period we to reply within the set or extended period for reply will, by statute, ply received by the Office later than three months after the mailing of patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim rill apply and will expire SIX (6) MONTHS from to cause the application to become ABANDONED	l. ely filed the mailing date of this communication. 0 (35 U.S.C. § 133).		
Status					
2a)⊠ 3 3)□ \$	Responsive to communication(s) filed on <u>8/30/6</u> This action is <b>FINAL</b> . 2b) This Since this application is in condition for allowan closed in accordance with the practice under <i>E</i>	action is non-final. ace except for formal matters, pro			
Dispositio	on of Claims				
5)	Claim(s) 14,20,21 and 23-26 is/are pending in to a) Of the above claim(s) is/are withdraw Claim(s) is/are allowed. Claim(s) 14,20,21 and 23-26 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and/or	vn from consideration.			
Application	on Papers				
10) T	the specification is objected to by the Examiner The drawing(s) filed on is/are: a) access applicant may not request that any objection to the correction drawing sheet(s) including the correction of the oath or declaration is objected to by the Examiner.	epted or b) objected to by the Edrawing(s) be held in abeyance. See on is required if the drawing(s) is objected	ected to. See 37 CFR 1.121(d).		
Priority ur	nder 35 U.S.C. § 119				
<ul> <li>12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).</li> <li>a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority documents have been received.</li> <li>2. Certified copies of the priority documents have been received in Application No.</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>					
Attachment(		. 🗖			
2) Notice 3) Informa	of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PTO-948) ation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) No(s)/Mail Date	4) Interview Summary ( Paper No(s)/Mail Dai 5) Notice of Informal Pa 6) Other:	te		

Application/Control Number: 10/618,067

Art Unit: 2822

## **DETAILED ACTION**

This Office Action is in response to the amendment filed 8/30/07.

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 14,20,21 and 23-26 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hshieh (U.S. Patent 6,051,468) in view of Itho (U.S. Patent 5,034,341).

In re claim 14, Hshieh discloses a power semiconductor device (Fig. 6) that comprises a semiconductor substrate (44), a source layer (58) at one surface of the substrate and comprising a high concentration of a dopant of first polarity (N), a single drain (64) on the other surface of the substrate, a well layer (60) beneath the source layer doped with a second polarity (P) opposite the first polarity, a region (62) lightly doped with the one polarity (N) positioned above drain region and below the well layer, a plurality of trenches (48) penetrating the source line and terminating in said region lightly doped with said one polarity, trenches substantially filled with a conductive material (52), a highly conductive layer (118) on the surface of the source layer comprising a material reacted from a metal and the substrate, an insulating layer (66)

Application/Control Number: 10/618,067

Art Unit: 2822

on the highly conductive layer and on the conductive material in the trenches, vias formed in the insulating layer and extending to the highly conductive layer on the source line and conductive material (68) filling the vias for contacting the highly conductive layer. Hshieh discloses all the limitations except the highly conductive path extending from the first trench to the second trench. Whereas Itoh discloses a semiconductor device (Fig. 4) that contains a first and second trench (79) and a highly conductive layer (73) that extends from one trench to another trench. The highly conductive layer extends across the trenches to form a bitline for the device. Therefore it would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the device of Hshieh by incorporating the highly conductive layer to extend across the trenches to form a bitline for the device as taught by Itoh.

In re claim 20, the trenches are filled with polysilicon (Col. 5, lines 14-17) and the top surface of the polysilicon is covered with a highly conductive material (120) reacted from a metal and the substrate.

In re claim 21, the highly conductive layer is a silicide. (Col. 10, lines 1-3)

In re claim 23, the silicide is reacted from titanium. (Col. 10, lines 1-3)

In re claim 24, the insulating material is BPSG or PSG. (Col. 7, lines 24-26)

In re claim 25, the trenches are lined with a trench wall insulating material (54) and the insulating material on the highly conductive layer contacts the ends of the trench wall insulating layer lining the walls of the trench. (Fig. 6)

Application/Control Number: 10/618,067

Art Unit: 2822

In re claim 26, the vias terminated on the surface of the highly conductive layer for making electrical connection between the highly conductive source layer and the conductive material filling the vias. (Fig. 6)

## Response to Arguments

Applicant's arguments with respect to claims 14, 21 and 23-24 have been considered but are most in view of the new ground(s) of rejection.

## Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, THIS ACTION IS MADE FINAL. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Application/Control Number: 10/618,067 Page 5

Art Unit: 2822

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Kiesha L. Rose whose telephone number is 571-272-1844.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Zandra Smith can be reached on 571-272-2429. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

**KLR** 

Klesha L. Rose Primary Examiner